

7-506

07-10-2006

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OMB No. 0651-0027 (exp. 5/31/2002)
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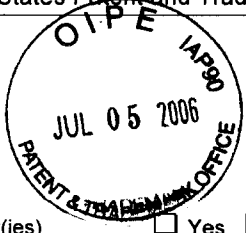
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1. Name of conveying party(ies):
Riichiro TAKEMURA

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: **Renesas Technology Corp.**

Address: **4-1, Marunouchi 2-chome**
Chiyoda-ku

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: **May 24, 2006**

City: **Tokyo** State/Prov.: _____
Country: **Japan** ZIP: _____

Additional name(s) & address(es) Yes No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: _____

Patent Application No.	Filing date	B. Patent No.(s)
11/002,245	December 3, 2004	

07/07/2006 DBYRNE 00000064 11002245
01 FC:8021 **40.00 OP** Additional numbers Yes No

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Mitchell W. Shapiro**

Registration No. **31,568**

Address: **Miles & Stockbridge P.C.**
1751 Pinnacle Drive
Suite 500

City: **McLean** State/Prov.: **VA**
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Mitchell W. Shapiro **July 5, 2006**
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and document: **2**

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Mail Stop Assignment Recordation Services
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Assignment

WHEREAS, I/We Riichiro TAKEMURA

have made an invention entitled SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE
for which I/We have executed an application for Letters Patent of the United States on even date
herewith or on _____ (date), or filed an application for Letters Patent of the United States on
December 3, 2004 (date) under Application No. 11/002,245; and

WHEREAS, RENESAS TECHNOLOGY CORP. ("ASSIGNEE"),
a citizen of _____ or a corporation or other business entity duly organized under
the laws of Japan, whose postal address is 4-1, Marunouchi 2-chome,
Chiyoda-ku, Tokyo, Japan
desires to acquire the entire right, title, and interest in the United States in and to the invention, the
application, and any Letters Patent of the United States to be granted for the invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) paid to me/us by ASSIGNEE,
and other good and valuable consideration, the receipt and sufficiency of which I/We acknowledge,
I/We, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over
unto ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest
in the United States in and to the invention, the application, all applications claiming benefit of the
application, including, but not limited to, all divisions and continuations of the application, and all
Letters Patent of the United States that may be granted thereon, and all reissues thereof; and I/We
authorize and request the Commissioner of Patents and Trademarks to issue all Letters Patent for the
invention to ASSIGNEE, its successors, legal representatives, and assigns in accordance with the
terms of this Assignment;

AND I/We covenant and agree that I/We have the full right to convey the entire right, title, and
interest herein assigned and that I/We have not executed and will not execute any assignment or
other instrument in conflict with this Assignment;

AND I/We further covenant and agree that upon request by ASSIGNEE, its successors, legal
representatives, and/or assigns, and without further consideration, I/We will do all lawful acts that may
be necessary or desirable to assist ASSIGNEE, its successors, legal representatives, and/or assigns
to obtain and enforce patent protection for the invention in the United States of America, including, but
not limited to, communicate with ASSIGNEE, its successors, legal representatives, and/or assigns
any facts known to me/us regarding the invention, testify in any legal proceeding, sign all lawful
papers, execute and deliver all papers that may be necessary or desirable to perfect the title to the
invention in ASSIGNEE, its successors, legal representatives, and/or assigns, execute all divisional,
continuation, and reissue applications, and make all rightful oaths, it being understood that any
expense incident to the rendering of such assistance will be borne by ASSIGNEE, its successors,
legal representatives, and/or assigns.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated
below.

Signature: Riichiro Takemura

Signature: _____

Date: 5 / 24 / 2006

Date: _____

Full Name: Riichiro TAKEMURA

Full Name: _____

Address: c/o Hitachi, Ltd.,

Address: _____

12th Floor, Marunouchi Center Building 6-1,

Marunouchi 1-chome, Chiyoda-ku, Tokyo Japan
